DuPont™ EKC900™ Series universal remover products

For Positive and Negative Photoresist Removal

DuPont™ EKC900™ universal remover products are organic mixtures designed to remove negative and positive photoresist and other organic compounds when an ultra clean semiconductor surface is required.

These products provide extended bath life and when used with a solvent rinse, will not harm most materials used to manufacture semiconductor devices such as photomask plates, printed circuit boards and other related products used in the microelectronics industry. As an additional benefit, the Universal remover products contain no phenol or chlorinated solvents.

DuPont™ EKC900™ Series universal remover products include:

**EKC922™**
Original formulation compatible with sensitive metals and III-V materials.

**EKC944™**
Designed for use at elevated temperatures for hard-to-remove photoresist layers. This product will remove harshly treated photoresist providing extremely clean surfaces as demonstrated by low CV shift.
For more information on Universal remover products or other products from DuPont EKC Technology, please contact your local representative, or visit our website:

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Caution: Do not use in medical applications involving permanent implantation in the human body. For other medical applications, see “DuPont Medical Caution Statement: H-51459 or H-50102-2”